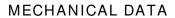




Glass Passivated Bridge Rectifiers

FEATURES

- Ideal for printed circuit board
- Reliable low cost construction utilizing molded plastic technique
- High surge current capability
- UL Recognized File # E-326243
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition



Case: Molded plastic body

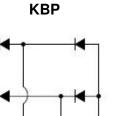
Molding compound, UL flammability classification rating 94V-0 Base P/N with suffix "G" on packing code - halogen-free **Terminal:** Matte tin plated leads, solderable per JESD22-B102

Meet JESD 201 class 1A whisker test **Polarity:** Polarity as marked on the body

Weight: 1.52 g (approximately)









MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T _A =25°C unless otherwise noted)									
PARAMETER		KBP	KBP	KBP	KBP	KBP	KBP	KBP	UNIT
FARAWETER	SYMBOL	101G	102G	103G	104G	105G	106G	107G	UNII
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current		1					Α		
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	30					А		
Rating for fusing (t<8.3mS)	l ² t	3.73						A ² s	
Maximum instantaneous forward voltage (Note 1) I _F = 1 A	V _F	1.0						V	
$ \begin{array}{lll} \text{Maximum DC reverse current} & & \text{T}_J = 25 \ ^{\circ}\text{C} \\ \text{at rated DC blocking voltage} & & \text{T}_J = 125 \ ^{\circ}\text{C} \\ \end{array} $	I _R	10 500				μA			
Typical thermal resistance	$R_{ hetajL}$ $R_{ hetajA}$	10 28						°C/W	
Operating junction temperature range	T_J	- 55 to +150						οС	
Storage temperature range	T_{STG}	- 55 to +150					οС		

Note 1: Pulse Test with PW=300µs,1% Duty Cycle



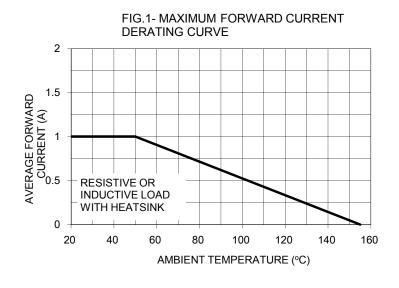
ORDERING INFORMATION					
PART NO.	PACKING CODE	GREEN COMPOUND CODE	PACKAGE	PACKING	
KBP10xG (Note 1)	C2	Suffix "G"	KBP	25 / TUBE	

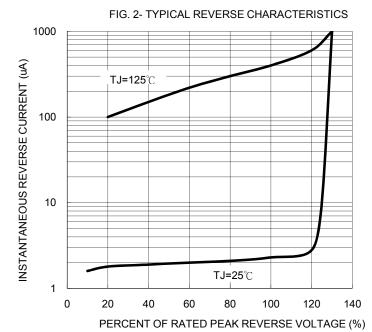
Note 1: "x" defines voltage from 50V (KBP101G) to 1000V (KBP107G)

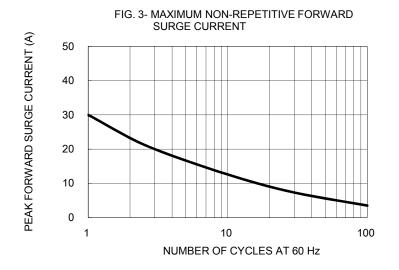
EXAMPLE							
PREFERRED P/N	PART NO.	PACKING CODE	GREEN COMPOUND CODE	DESCRIPTION			
KBP107G C2	KBP107G	C2					
KBP107G C2G	KBP107G	C2	G	Green compound			

RATINGS AND CHARACTERISTICS CURVES

(TA=25°C unless otherwise noted)







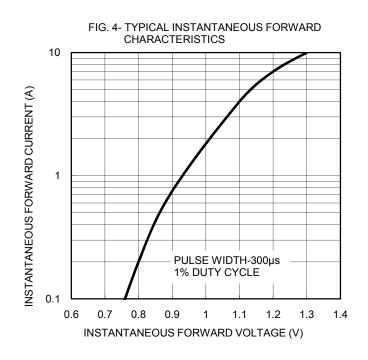
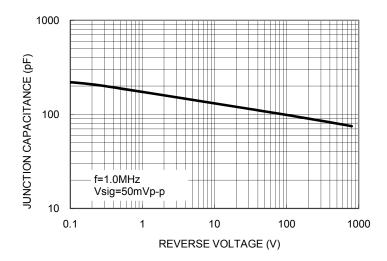
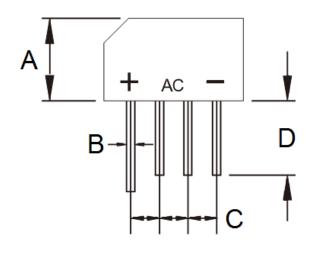


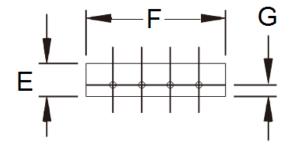


FIG. 5 TYPICAL JUNCTION CAPACITANCE



PACKAGE OUTLINE DIMENSIONS





DIM.	Unit	(mm)	Unit (inch)			
DIW.	Min	Max	Min	Max		
Α	10.60	11.68	0.417	0.460		
В	0.70	0.90	0.028	0.035		
С	3.60	4.10	0.142	0.161		
D	12.70	-	0.500	-		
Е	3.70	3.90	0.146	0.154		
F	14.22	15.24	0.560	0.600		
G	1.27	-	0.050	-		

MARKING DIAGRAM



P/N = Specific Device Code G = Green Compound

YW = Date Code

F = Factory Code





Taiwan Semiconductor

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